

### High speed and low saturation voltage 650 V TRENCHSTOP™ IGBT7 technology copacked with soft, fast recovery Emitter Controlled 7 diode

#### Features

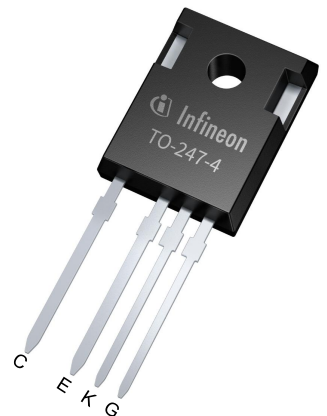
- $V_{CE} = 650\text{ V}$
- $I_C = 40\text{ A}$
- Low switching losses
- Very low collector-emitter saturation voltage  $V_{CEsat}$
- Very soft, fast recovery antiparallel diode
- Smooth switching behavior
- Humidity robustness
- Optimized for hard switching, two- and three-level topologies
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

#### Potential applications

- Industrial UPS
- EV-Charging
- String inverter
- Welding

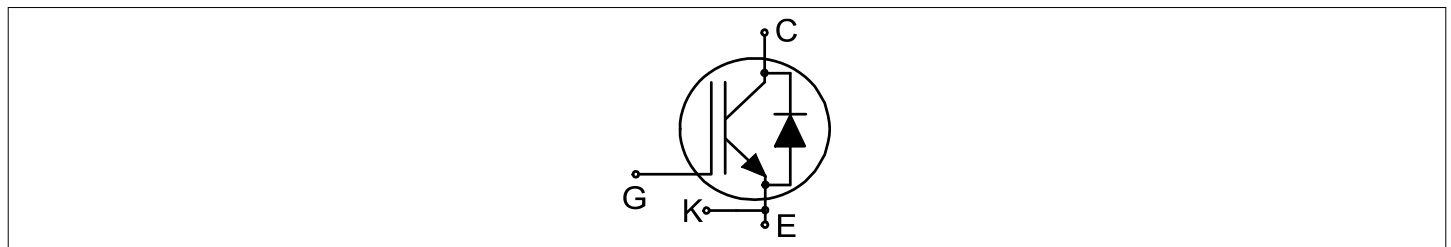
#### Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



- Lead-free
- Green
- Halogen-free
- RoHS

#### Description



Type	Package	Marking
IKZA40N65EH7	PG-TO247-4-STD-NT3.7	K40EEH7

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## 1 Package

**Table 1 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	$L_E$			13		nH
Storage temperature	$T_{stg}$		-55		150	°C
Soldering temperature	$T_{sold}$	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	$M$	M3 screw, Maximum of mounting process: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$			0.54	0.71	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$			0.72	0.94	K/W

## 2 IGBT

**Table 2 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Collector-emitter voltage	$V_{CE}$	$T_{vj} \geq 25\text{ °C}$	650	V	
DC collector current, limited by $T_{vjmax}$	$I_C$	limited by bondwire	$T_c = 25\text{ °C}$	80	A
			$T_c = 100\text{ °C}$	64	
Pulsed collector current, $t_p$ limited by $T_{vjmax}$	$I_{Cpulse}$		160	A	
Turn-off safe operating area		$V_{CE} \leq 650\text{ V}$ , $t_p \leq 1\text{ }\mu\text{s}$ , $T_{vj} \leq 175\text{ °C}$	160	A	
Gate-emitter voltage	$V_{GE}$		$\pm 20$	V	
Transient gate-emitter voltage	$V_{GE}$	$t_p \leq 10\text{ }\mu\text{s}$ , $D < 0.01$	$\pm 30$	V	
Power dissipation	$P_{tot}$		$T_c = 25\text{ °C}$	210	W
			$T_c = 100\text{ °C}$	105	

**Table 3 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CEsat}$	$I_C = 40\text{ A}$ , $V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$	1.4	1.65	V
			$T_{vj} = 175\text{ °C}$	1.6		

**(table continues...)**  
 Datasheet

**Table 3 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Gate-emitter threshold voltage	$V_{GEth}$	$I_C = 0.35 \text{ mA}, V_{CE} = V_{GE}$	2.9	3.85	4.8	V
Zero gate-voltage collector current	$I_{CES}$	$V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ °C}$		10	$\mu\text{A}$
			$T_{vj} = 175 \text{ °C}$		1200	
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$			100	nA
Transconductance	$g_{fs}$	$I_C = 40 \text{ A}, V_{CE} = 20 \text{ V}$		67		S
Input capacitance	$C_{ies}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$		2026		pF
Output capacitance	$C_{oes}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$		71.4		pF
Reverse transfer capacitance	$C_{res}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$		9.1		pF
Gate charge	$Q_G$	$V_{CC} = 520 \text{ V}, I_C = 40 \text{ A}, V_{GE} = 15 \text{ V}$		81		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 12.5 \text{ }\Omega, R_{G(off)} = 12.5 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}, I_C = 40 \text{ A}$		13	ns
			$T_{vj} = 175 \text{ °C}, I_C = 40 \text{ A}$		13	
Rise time (inductive load)	$t_r$	$V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 12.5 \text{ }\Omega, R_{G(off)} = 12.5 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}, I_C = 40 \text{ A}$		8	ns
			$T_{vj} = 175 \text{ °C}, I_C = 40 \text{ A}$		11	
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 12.5 \text{ }\Omega, R_{G(off)} = 12.5 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}, I_C = 40 \text{ A}$		134	ns
			$T_{vj} = 175 \text{ °C}, I_C = 40 \text{ A}$		168	
Fall time (inductive load)	$t_f$	$V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 12.5 \text{ }\Omega, R_{G(off)} = 12.5 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}, I_C = 40 \text{ A}$		13	ns
			$T_{vj} = 175 \text{ °C}, I_C = 40 \text{ A}$		17	
Turn-on energy	$E_{on}$	$V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 12.5 \text{ }\Omega, R_{G(off)} = 12.5 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}, I_C = 40 \text{ A}$		0.37	mJ
			$T_{vj} = 175 \text{ °C}, I_C = 40 \text{ A}$		0.65	
Turn-off energy	$E_{off}$	$V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{G(on)} = 12.5 \text{ }\Omega, R_{G(off)} = 12.5 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}, I_C = 40 \text{ A}$		0.36	mJ
			$T_{vj} = 175 \text{ °C}, I_C = 40 \text{ A}$		0.77	

(table continues...)

**Table 3 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Total switching energy	$E_{ts}$	$V_{CC} = 400\text{ V}$ , $V_{GE} = 0/15\text{ V}$ , $R_{G(on)} = 12.5\ \Omega$ , $R_{G(off)} = 12.5\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$ , $I_C = 40\text{ A}$		0.73	mJ
			$T_{vj} = 175\text{ }^\circ\text{C}$ , $I_C = 40\text{ A}$		1.42	
Operating junction temperature	$T_{vj}$		-40		175	$^\circ\text{C}$

### 3 Diode

**Table 4 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Diode forward current, limited by $T_{vjmax}$	$I_F$		$T_c = 25\text{ }^\circ\text{C}$	76	A
			$T_c = 100\text{ }^\circ\text{C}$	49	
Diode pulsed current, $t_p$ limited by $T_{vjmax}$	$I_{Fpulse}$		160	A	
Power dissipation	$P_{tot}$		$T_c = 25\text{ }^\circ\text{C}$	159	W
			$T_c = 100\text{ }^\circ\text{C}$	80	

**Table 5 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode forward voltage	$V_F$	$I_F = 40\text{ A}$	$T_{vj} = 25\text{ }^\circ\text{C}$	1.65	2	V
			$T_{vj} = 175\text{ }^\circ\text{C}$	1.55		
Diode reverse recovery time	$t_{rr}$	$V_R = 400\text{ V}$ , $R_{G(on)} = 12.5\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$ , $I_F = 40\text{ A}$	49.6		ns
			$T_{vj} = 175\text{ }^\circ\text{C}$ , $I_F = 40\text{ A}$	80		
Diode reverse recovery charge	$Q_{rr}$	$V_R = 400\text{ V}$ , $R_{G(on)} = 12.5\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$ , $I_F = 40\text{ A}$	1.09		$\mu\text{C}$
			$T_{vj} = 175\text{ }^\circ\text{C}$ , $I_F = 40\text{ A}$	2.75		
Diode peak reverse recovery current	$I_{rrm}$	$V_R = 400\text{ V}$ , $R_{G(on)} = 12.5\ \Omega$	$T_{vj} = 25\text{ }^\circ\text{C}$ , $I_F = 40\text{ A}$	38		A
			$T_{vj} = 175\text{ }^\circ\text{C}$ , $I_F = 40\text{ A}$	64.6		

**(table continues...)**

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode peak rate of fall of reverse recovery current	$di_{rr}/dt$	$V_R = 400 \text{ V}$ , $R_{G(on)} = 12.5 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$ , $I_F = 40 \text{ A}$		-1340		A/ $\mu\text{s}$
			$T_{vj} = 175 \text{ }^\circ\text{C}$ , $I_F = 40 \text{ A}$		-1460		
Reverse recovery energy	$E_{rec}$	$V_R = 400 \text{ V}$ , $R_{G(on)} = 12.5 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$ , $I_F = 40 \text{ A}$		0.3		mJ
			$T_{vj} = 175 \text{ }^\circ\text{C}$ , $I_F = 40 \text{ A}$		0.78		
Operating junction temperature	$T_{vj}$			-40		175	$^\circ\text{C}$

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

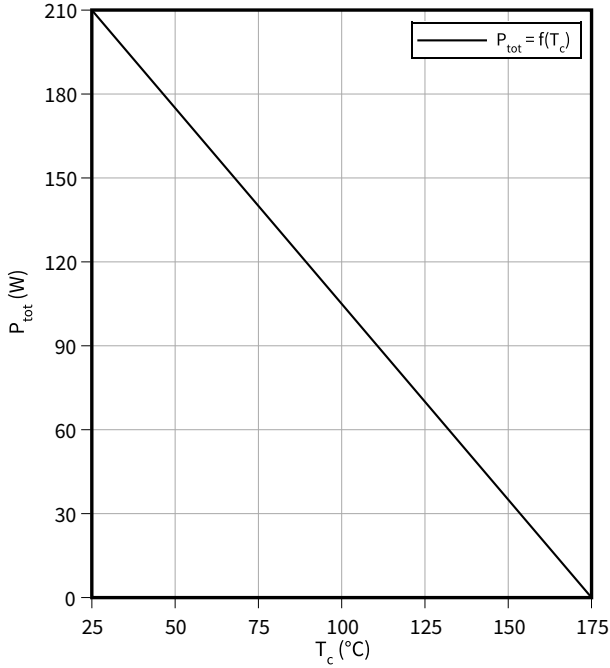
Electrical Characteristic at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified.

Dynamic test circuit, parasitic inductance  $L_\sigma = 8 \text{ nH}$ , parasitic capacitor  $C_\sigma = 30 \text{ pF}$  from Fig. E. Energy losses include "tail" and diode reverse recovery.

## 4 Characteristics diagrams

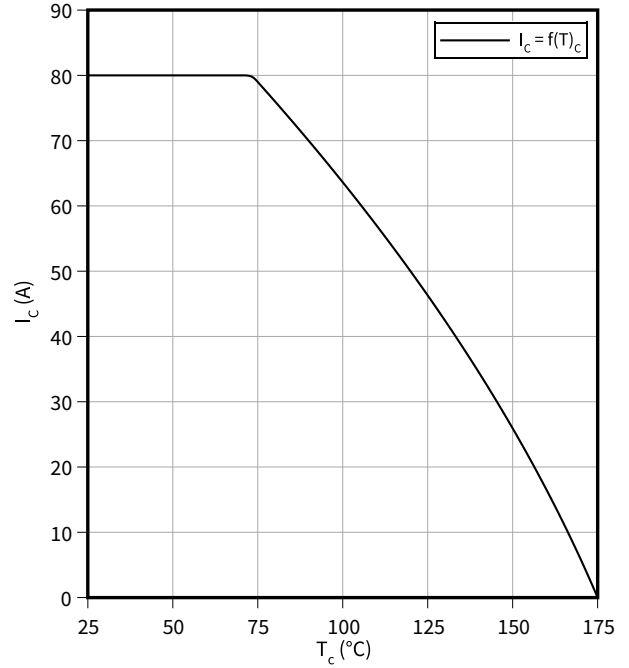
### Power dissipation as a function of case temperature

$P_{tot} = f(T_c)$   
 $T_{vj} \leq 175\text{ °C}$



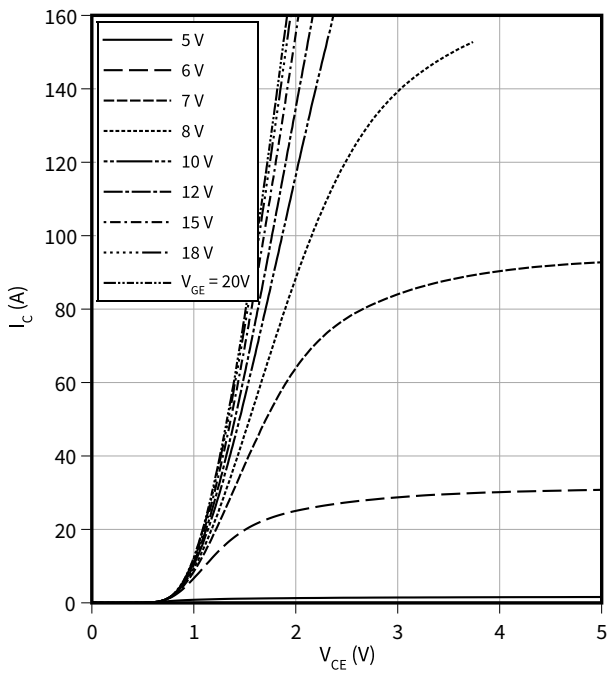
### Collector current as a function of case temperature

$I_C = f(T_c)$   
 $T_{vj} \leq 175\text{ °C}, V_{GE} \geq 15\text{ V}$



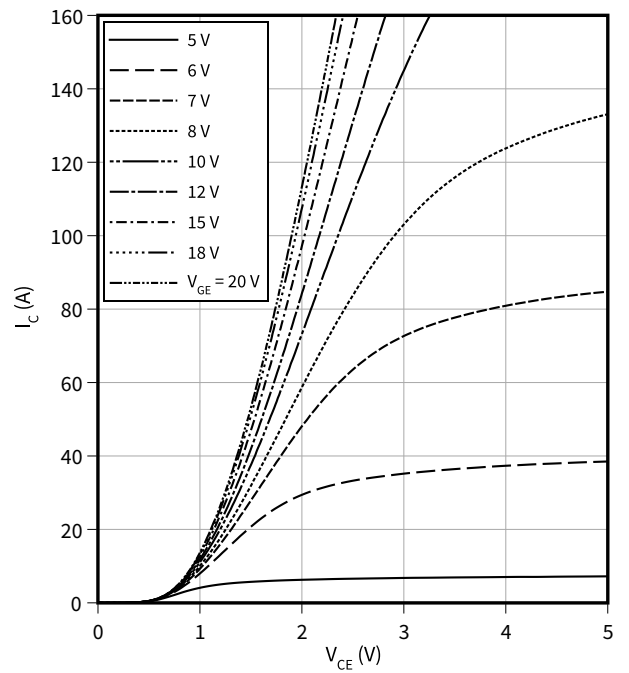
### Typical output characteristic

$I_C = f(V_{CE})$   
 $T_{vj} = 25\text{ °C}$



### Typical output characteristic

$I_C = f(V_{CE})$   
 $T_{vj} = 175\text{ °C}$

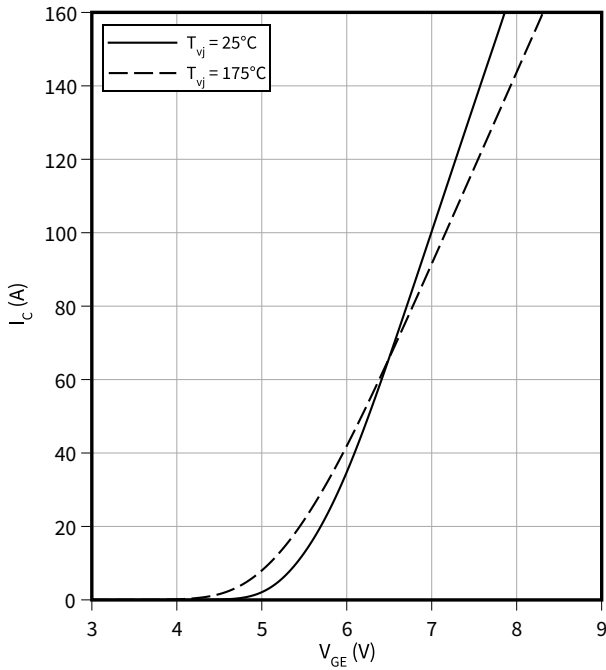


4 Characteristics diagrams

**Typical transfer characteristic**

$I_C = f(V_{GE})$

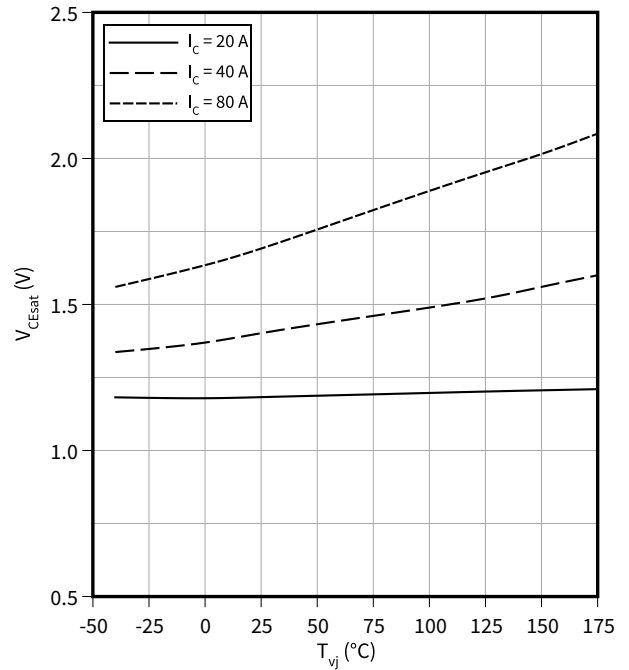
$V_{CE} = 20\text{ V}$



**Typical collector-emitter saturation voltage as a function of junction temperature**

$V_{CEsat} = f(T_{vj})$

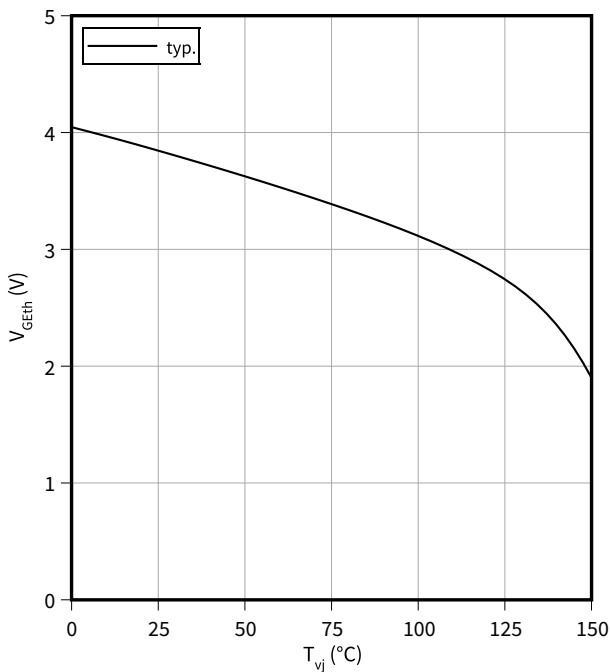
$V_{GE} = 15\text{ V}$



**Gate-emitter threshold voltage as a function of junction temperature**

$V_{GEth} = f(T_{vj})$

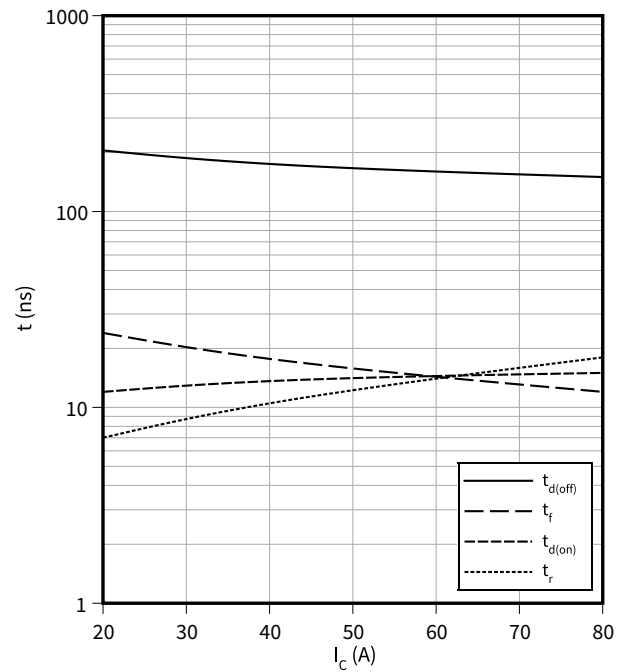
$I_C = 0.35\text{ mA}$



**Typical switching times as a function of collector current**

$t = f(I_C)$

$V_{CC} = 400\text{ V}, T_{vj} = 175^\circ\text{C}, V_{GE} = 0/15\text{ V}, R_G = 12.5\ \Omega$

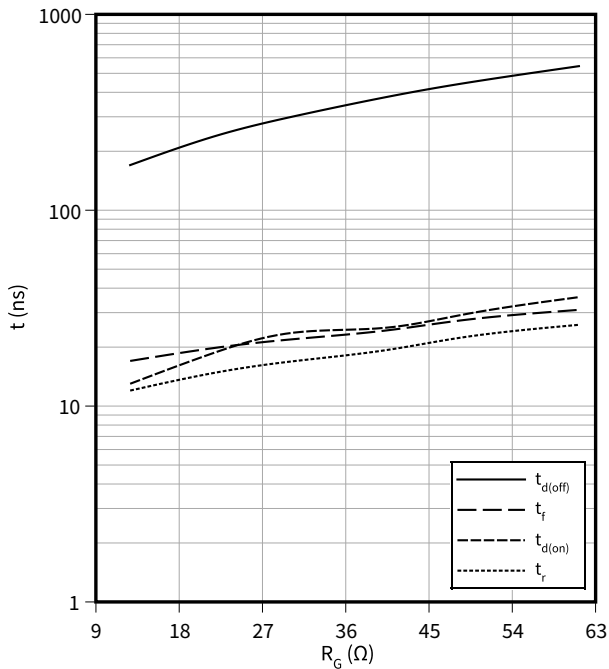


4 Characteristics diagrams

**Typical switching times as a function of gate resistor**

$t = f(R_G)$

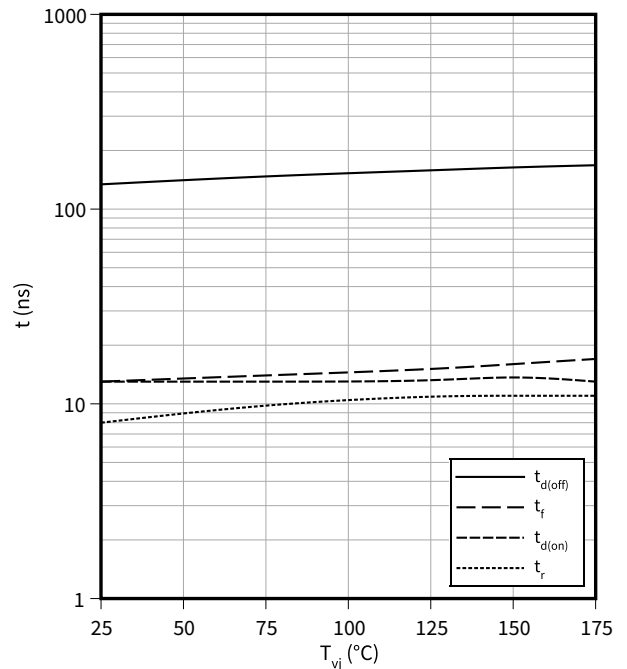
$I_C = 40\text{ A}, V_{CC} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}$



**Typical switching times as a function of junction temperature**

$t = f(T_{vj})$

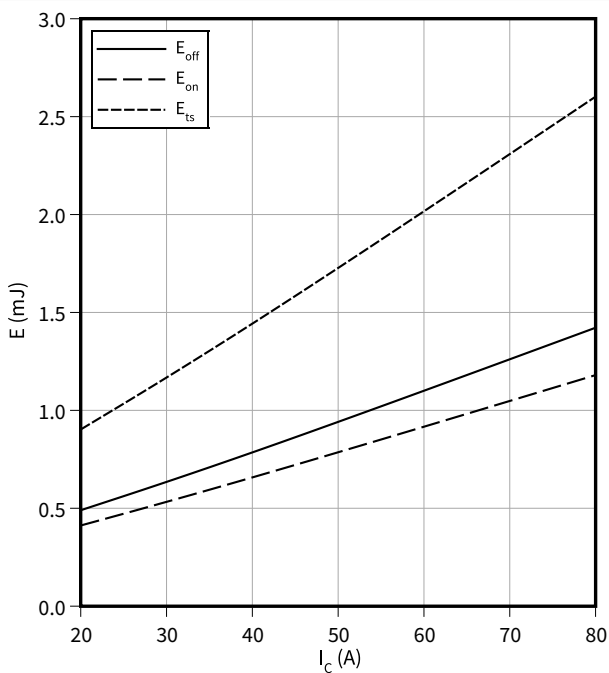
$I_C = 40\text{ A}, V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V}, R_G = 12.5\text{ }\Omega$



**Typical switching energy losses as a function of collector current**

$E = f(I_C)$

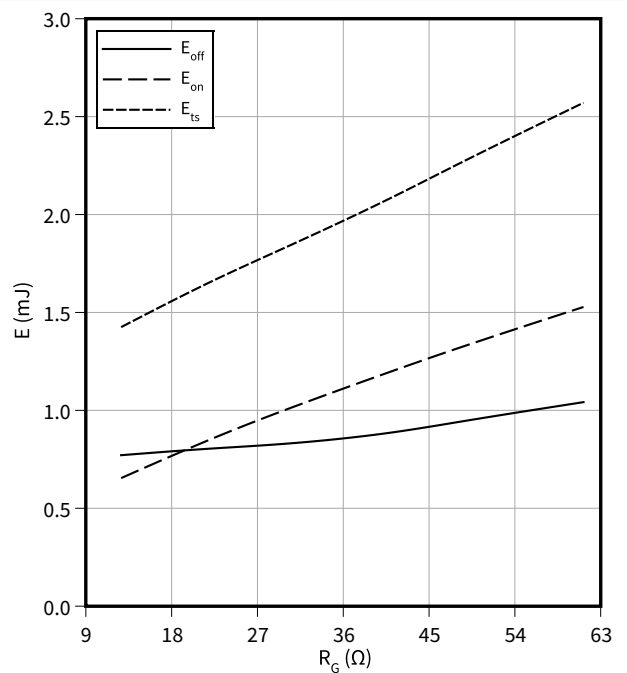
$V_{CC} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}, R_G = 12.5\text{ }\Omega$



**Typical switching energy losses as a function of gate resistor**

$E = f(R_G)$

$I_C = 40\text{ A}, V_{CC} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}$

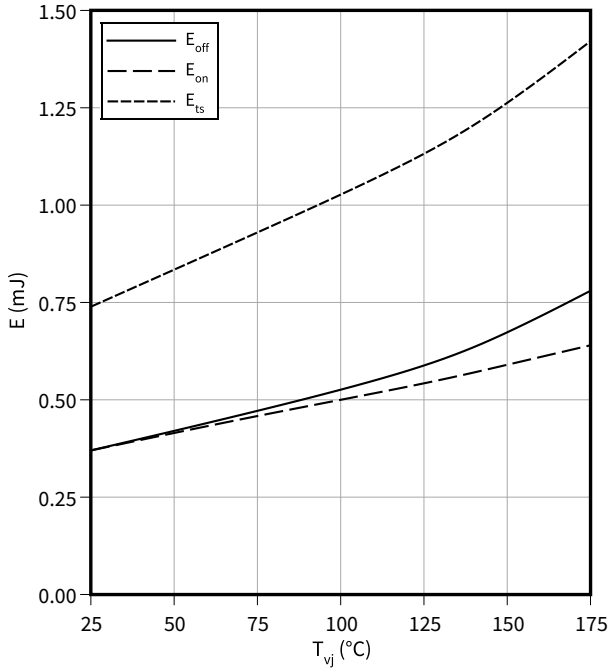


4 Characteristics diagrams

**Typical switching energy losses as a function of junction temperature**

$E = f(T_{vj})$

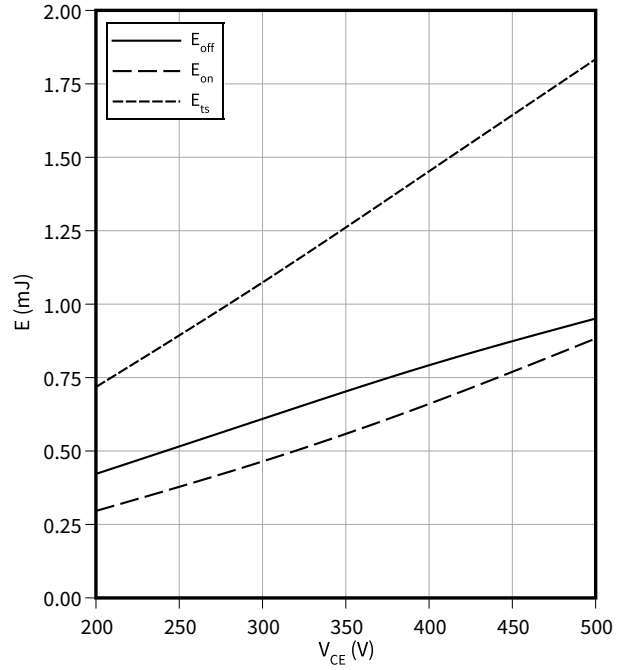
$I_C = 40\text{ A}$ ,  $V_{CC} = 400\text{ V}$ ,  $V_{GE} = 0/15\text{ V}$ ,  $R_G = 12.5\ \Omega$



**Typical switching energy losses as a function of collector emitter voltage**

$E = f(V_{CE})$

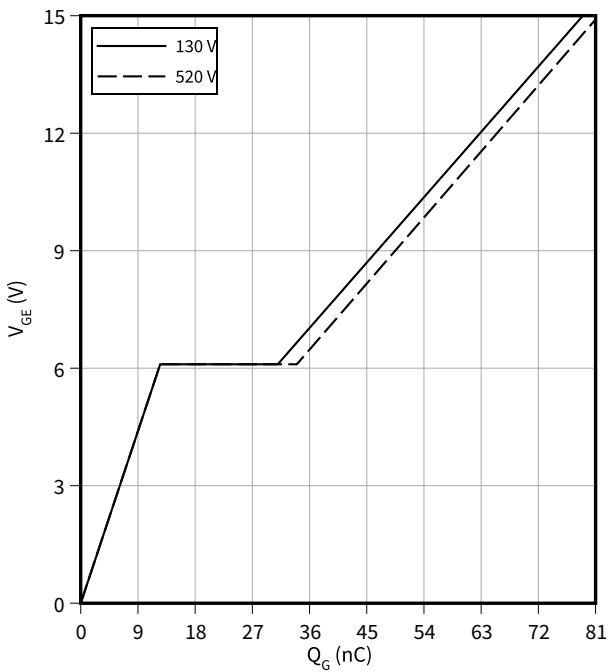
$I_C = 40\text{ A}$ ,  $T_{vj} = 175\text{ °C}$ ,  $V_{GE} = 0/15\text{ V}$ ,  $R_G = 12.5\ \Omega$



**Typical gate charge**

$V_{GE} = f(Q_G)$

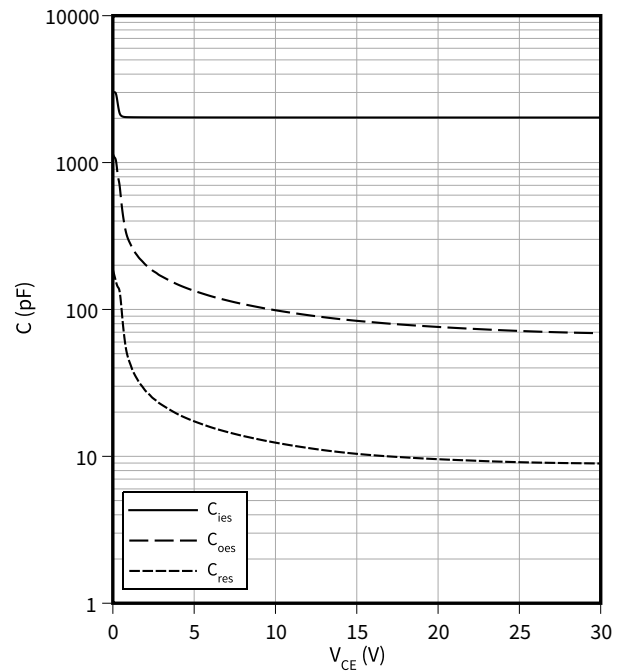
$I_C = 40\text{ A}$



**Typical capacitance as a function of collector-emitter voltage**

$C = f(V_{CE})$

$f = 100\text{ kHz}$ ,  $V_{GE} = 0\text{ V}$

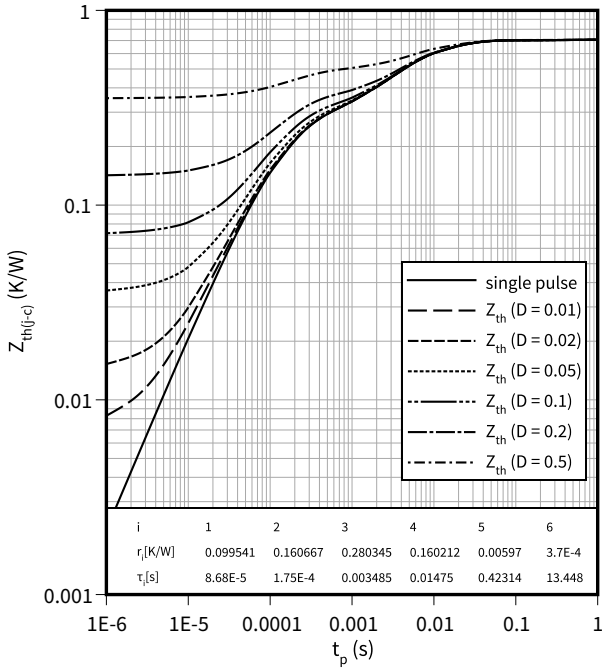


4 Characteristics diagrams

**IGBT transient thermal impedance as a function of pulse width**

$$Z_{th(j-c)} = f(t_p)$$

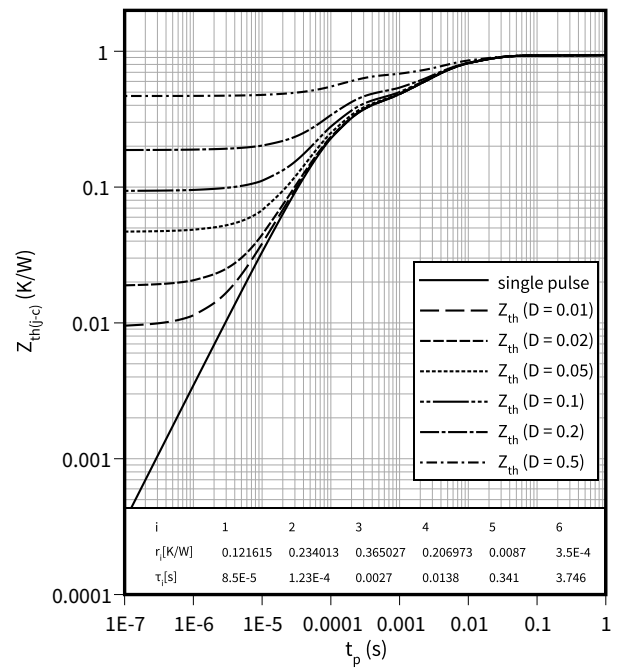
$$D = t_p/T$$



**Diode transient thermal impedance as a function of pulse width**

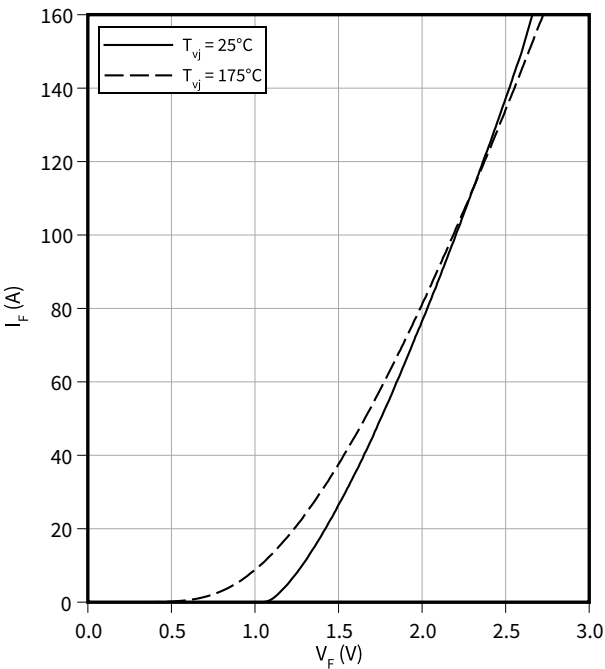
$$Z_{th(j-c)} = f(t_p)$$

$$D = t_p/T$$



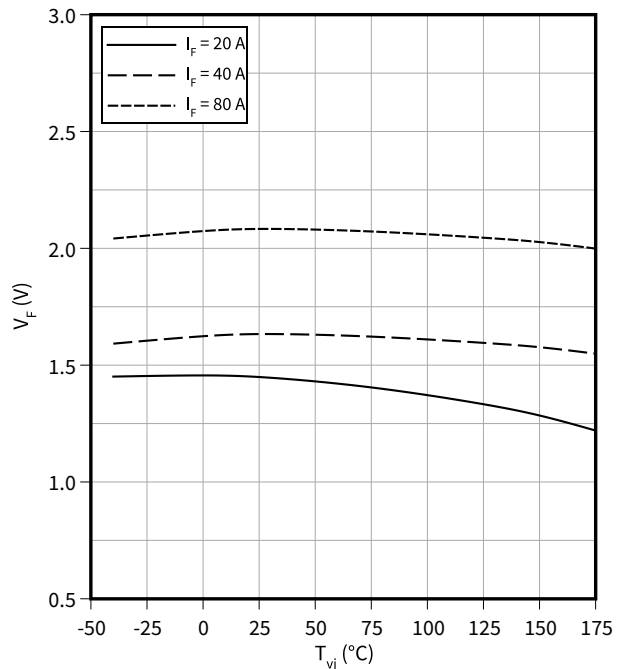
**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$



**Typical diode forward voltage as a function of junction temperature**

$$V_F = f(T_{vj})$$

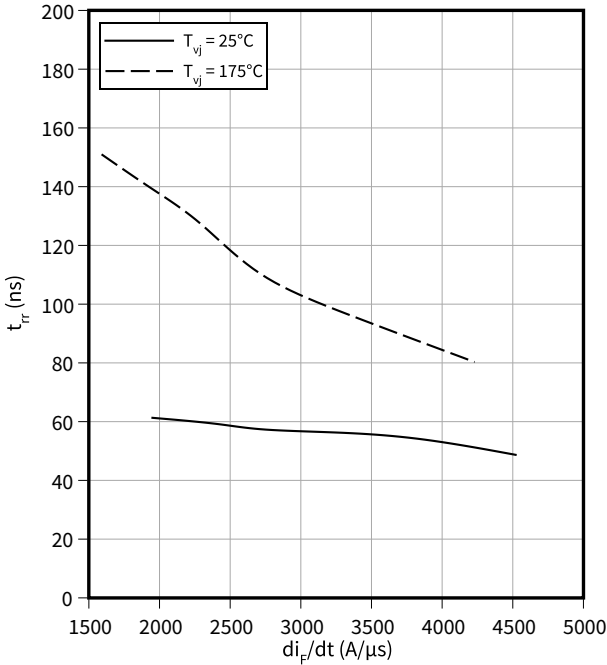


4 Characteristics diagrams

**Typical reverse recovery time as a function of diode current slope**

$t_{rr} = f(di_F/dt)$

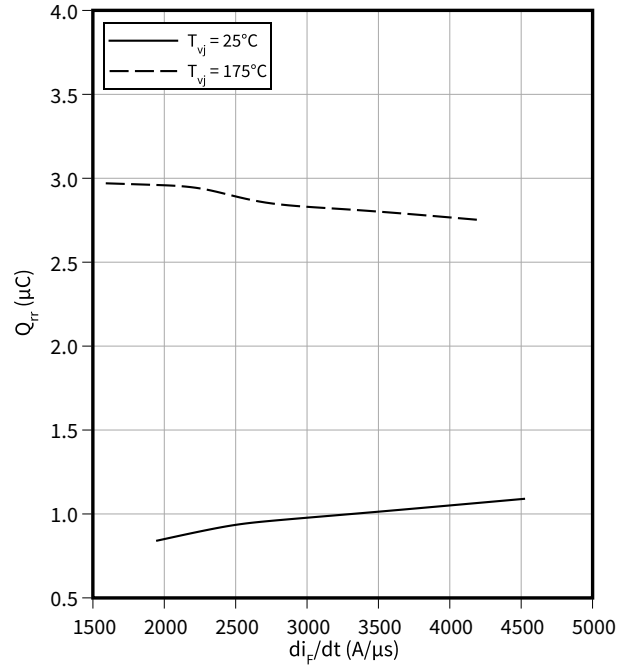
$V_R = 400\text{ V}, I_F = 40\text{ A}$



**Typical reverse recovery charge as a function of diode current slope**

$Q_{rr} = f(di_F/dt)$

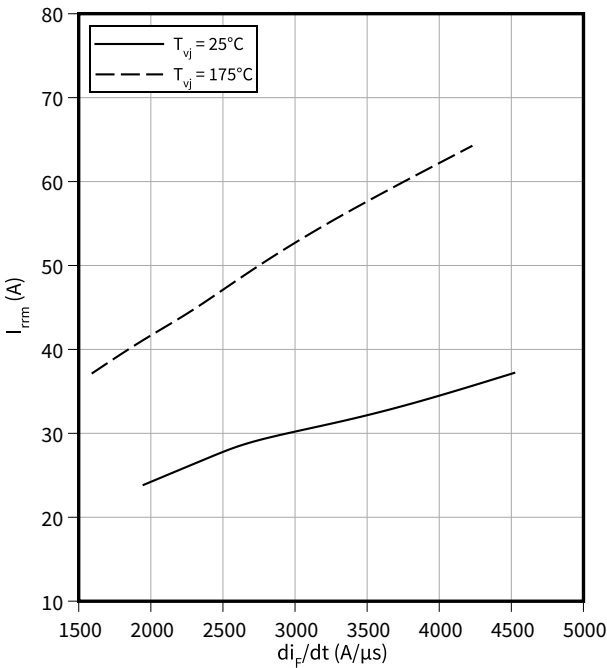
$V_R = 400\text{ V}, I_F = 40\text{ A}$



**Typical reverse recovery current as a function of diode current slope**

$I_{rrm} = f(di_F/dt)$

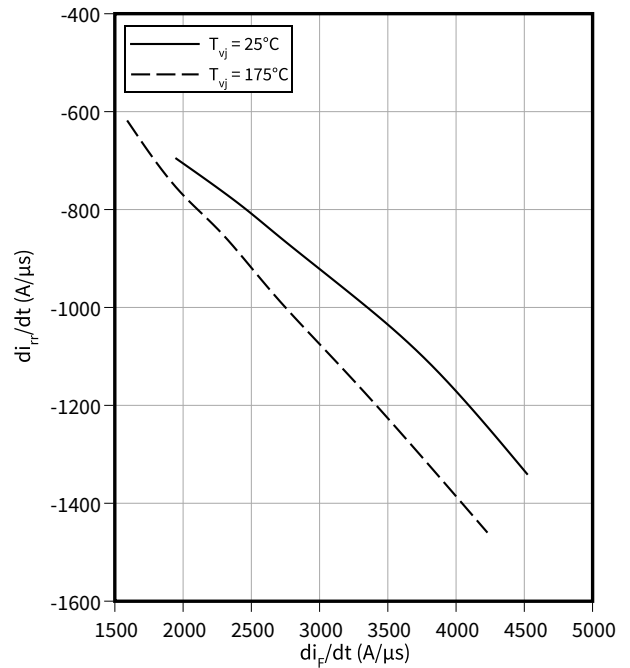
$V_R = 400\text{ V}, I_F = 40\text{ A}$



**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

$di_{rr}/dt = f(di_F/dt)$

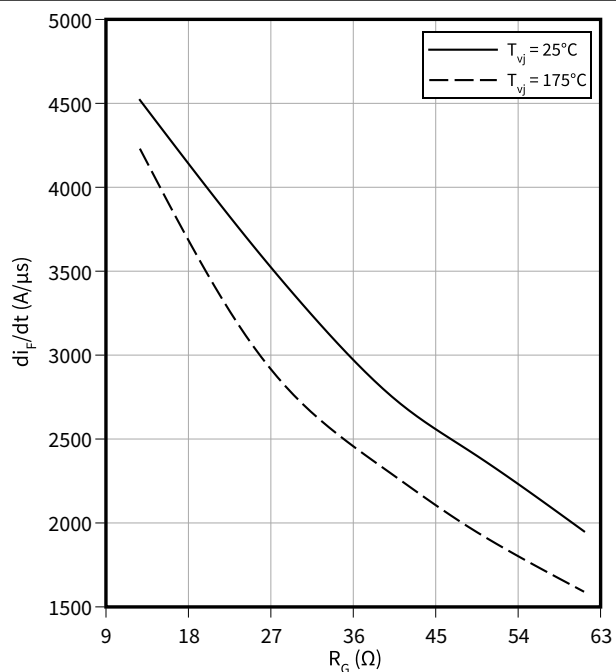
$V_R = 400\text{ V}, I_F = 40\text{ A}$



**Typical diode current slope as a function of gate resistor**

$di_F/dt = f(R_G)$

$V_R = 400\text{ V}, I_F = 40\text{ A}$



5 Package outlines

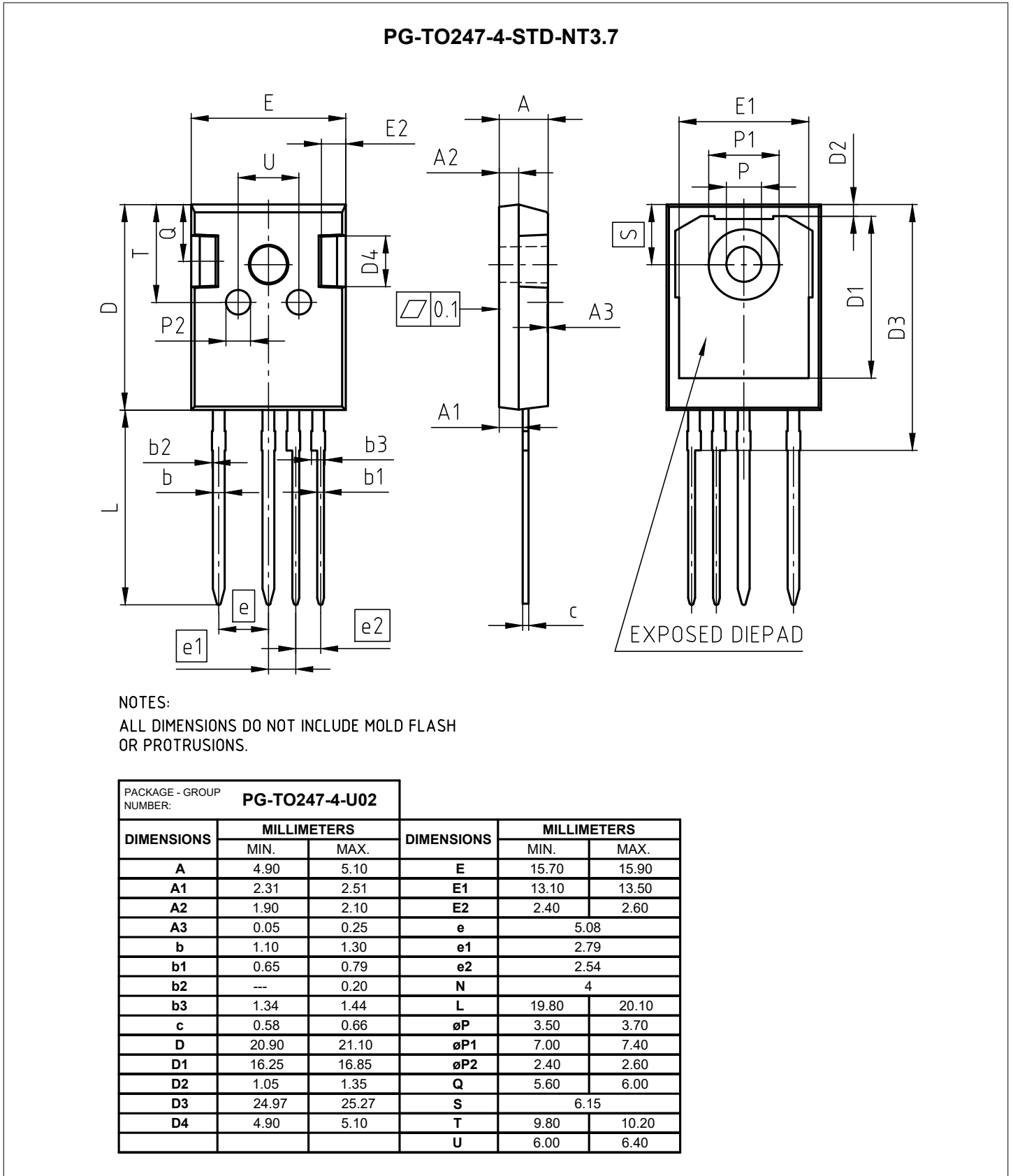


Figure 1

6 Testing conditions

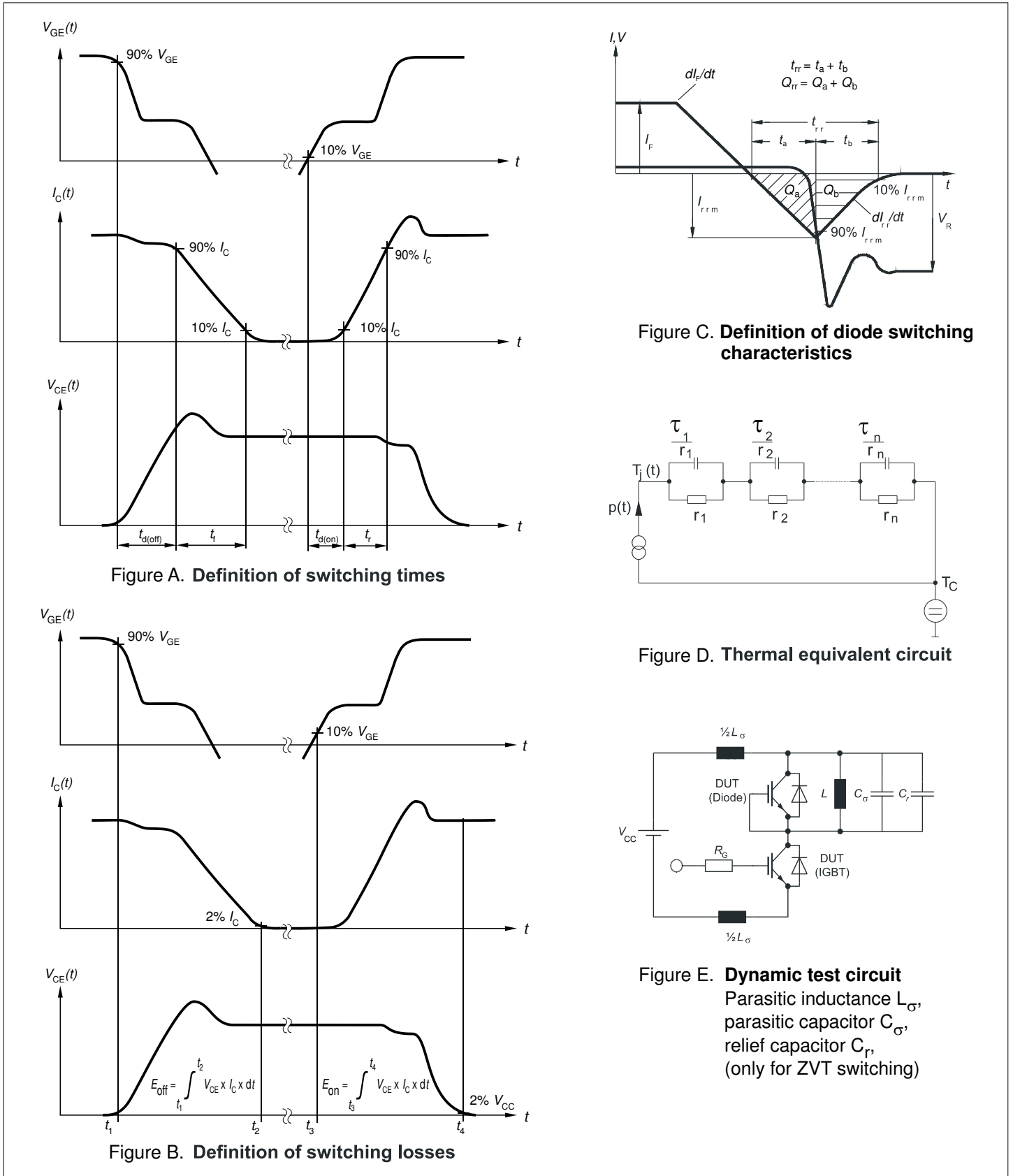


Figure 2

## Revision history

Document revision	Date of release	Description of changes
1.00	2023-04-27	Final datasheet

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Please note that this product is not qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

## Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.